Octal D-type flip-flop; 5 V tolerant inputs/outputs; positive-edge trigger; 3-state

Rev. 3 — 6 December 2012

Product data sheet

1. General description

The 74LVC374A is an octal D-type flip-flop featuring separate D-type inputs for each flip-flop and 3-state outputs for bus-oriented applications. A clock input (CP) and an outputs enable input (\overline{OE}) are common to all flip-flops.

The eight flip-flops will store the state of their individual D-inputs that meet the set-up and hold times requirements on the LOW-to-HIGH CP transition.

When pin \overline{OE} is LOW, the contents of the eight flip-flops is available at the outputs. When pin \overline{OE} is HIGH, the outputs go to the high-impedance OFF-state. Operation of the \overline{OE} input does not affect the state of the flip-flops.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs. These features allow the use of these devices as translators in mixed 3.3 V and 5 V applications.

The 74LVC374A is functionally identical to the 74LVC574A, but has a different pin arrangement.

2. Features and benefits

- 5 V tolerant inputs/outputs; for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Direct interface with TTL levels
- High-impedance when V_{CC} = 0 V
- 8-bit positive edge-triggered register
- Independent register and 3-state buffer operation
- Complies with JEDEC standard:
 - ◆ JESD8-7A (1.65 V to 1.95 V)
 - JESD8-5A (2.3 V to 2.7 V)
 - JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - ◆ HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-B exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



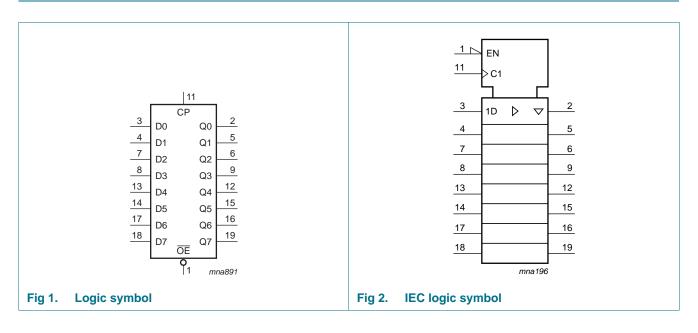
Octal D-type flip-flop; 5 V tolerant inputs/outputs; positive-edge trigger; 3-state

3. Ordering information

Table 1.Ordering information

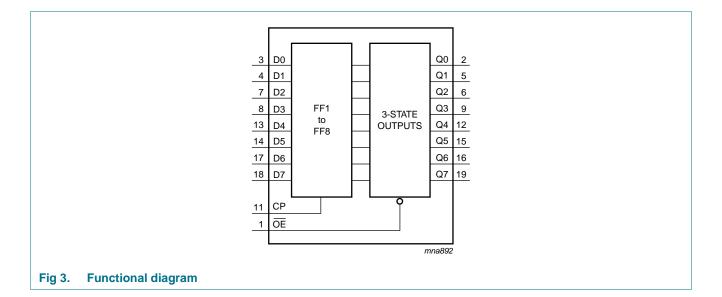
Type number	Package	Package								
	Temperature range	Name	Description	Version						
74LVC374AD	–40 °C to +125 °C	SO20	plastic small outline package; 20 leads; body width 7.5 mm	SOT163-1						
74LVC374ADB	–40 °C to +125 °C	SSOP20	plastic shrink small outline package; 20 leads; body width 5.3 mm	SOT339-1						
74LVC374APW	–40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package; 20 leads; body width 4.4 mm	SOT360-1						
74LVC374ABQ	–40 °C to +125 °C	DHVQFN20	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body $2.5 \times 4.5 \times 0.85$ mm	SOT764-1						

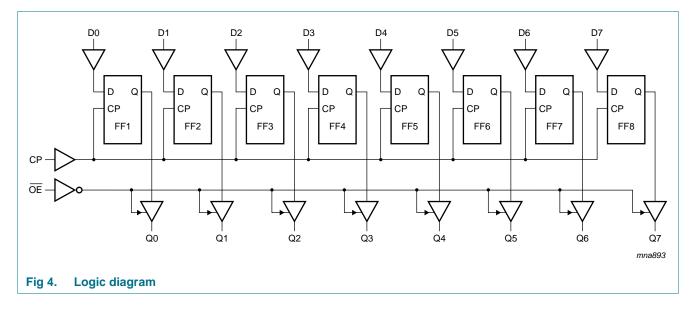
4. Functional diagram



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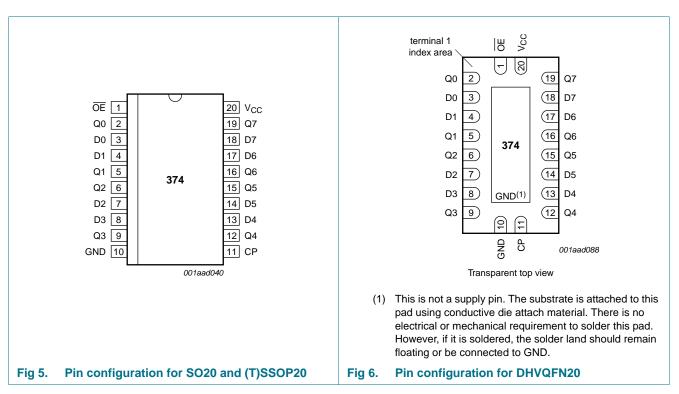


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5. Pinning information



5.1 Pinning

5.2 Pin description

Table 2. **Pin description** Symbol Pin Description OE output enable input (active LOW) 1 Q[0:7] 2, 5, 6, 9, 12, 15, 16, 19 3-state flip-flop output D[0:7] 3, 4, 7, 8, 13, 14, 17, 18 data input GND 10 ground (0 V) CP clock input (LOW-to-HIGH, edge-triggered) 11 20 V_{CC} supply voltage

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6. Functional description

Table 3.Function table^[1]

Operating mode	Input		Internal flip-flop	Output	
	OE	СР	Dn	_	Qn
Load and read register	L	\uparrow	I	L	L
	L	\uparrow	h	Н	Н
Load register and disable	Н	\uparrow	Ι	L	Z
outputs	Н	↑	h	Н	Z

[1] H = HIGH voltage level

h = HIGH voltage level one set-up time prior to the LOW-to-HIGH CP transition

L = LOW voltage level

I = LOW voltage level one set-up time prior to the LOW-to-HIGH CP transition

Z = high-impedance OFF-state

 \uparrow = LOW-to-HIGH clock transition

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+6.5	V
I _{IK}	input clamping current	V ₁ < 0 V		-50	-	mA
VI	input voltage		<u>[1]</u>	-0.5	+6.5	V
Ι _{ΟΚ}	output clamping current	$V_{O} > V_{CC}$ or $V_{O} < 0$ V		-	±50	mA
Vo	output voltage	output HIGH or LOW state	[2]	-0.5	V _{CC} + 0.5	V
		output 3-state	[2]	-0.5	+6.5	V
I _O	output current	$V_{O} = 0 V$ to V_{CC}		-	±50	mA
I _{CC}	supply current			-	100	mA
I _{GND}	ground current			-100	-	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \text{ to } +125 \ ^{\circ}C$	[3]	-	500	mW

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

[3] For SO20 packages: above 70 °C the value of P_{tot} derates linearly with 8 mW/K.
 For SSOP20 and TSSOP20 packages: above 60 °C the value of P_{tot} derates linearly with 5.5 mW/K.
 For DHVQFN20 packages: above 60 °C the value of P_{tot} derates linearly with 4.5 mW/K.

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8. Recommended operating conditions

Table 5.	Recommended operating cond	litions				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		1.65	-	3.6	V
		functional	1.2	-	-	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	output HIGH or LOW state	0	-	V_{CC}	V
		output 3-state	0	-	5.5	V
T _{amb}	ambient temperature	in free air	-40	-	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	V_{CC} = 1.65 V to 2.7 V	0	-	20	ns/V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	0	-	10	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40) °C to +8	5 °C	–40 °C to	o +125 ℃	Unit
			Min	Typ[1]	Мах	Min	Max	-
V _{IH}	HIGH-level	$V_{CC} = 1.2 V$	1.08	-	-	1.08	-	V
	input voltage	V_{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V
		V_{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2.0	-	-	2.0	-	V
V _{IL}	LOW-level	V _{CC} = 1.2 V	-	-	0.12	-	0.12	V
	input voltage	$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V
		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		V_{CC} = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
V _{OH}	V _{OH} HIGH-level output voltage	$V_I = V_{IH} \text{ or } V_{IL}$						
		$I_{O} = -100 \ \mu A;$ $V_{CC} = 1.65 \ V \ to \ 3.6 \ V$	$V_{CC} - 0.$ 2	-	-	$V_{CC}-0.3$	-	V
		$I_0 = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	I_{O} = 100 µA; V_{CC} = 1.65 V to 3.6 V	-	-	0.2	-	0.3	V
		$I_{O} = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V
		$I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	0.8	V
		$I_0 = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.4	-	0.6	V
		I_{O} = 24 mA; V_{CC} = 3.0 V	-	-	0.55	-	0.8	V

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Symbol	Parameter	Conditions	-4	0 °C to +8	5 °C	-40 °C to	o +125 ℃	Unit
			Min	Typ[1]	Max	Min	Max	
l _l	input leakage current	V_{CC} = 3.6 V; $V_{\rm I}$ = 5.5 V or GND	-	±0.1	±5	-	±20	μA
I _{OZ}	OFF-state output current	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 3.6 \text{ V}; \\ V_{O} = 5.5 \text{ V or GND};$	-	±0.1	±5	-	±20	μΑ
I _{OFF}	power-off leakage current	$V_{CC} = 0$ V; V_{I} or $V_{O} = 5.5$ V	-	±0.1	±10	-	±20	μΑ
I _{CC}	supply current	V_{CC} = 3.6 V; V_I = V_{CC} or GND; I_O = 0 A	-	0.1	10	-	40	μΑ
∆l _{CC}	additional supply current	per input pin; V _{CC} = 2.7 V to 3.6 V; V _I = V _{CC} – 0.6 V; I _O = 0 A	-	5	500	-	5000	μΑ
CI	input capacitance	$V_{CC} = 0 V \text{ to } 3.6 V;$ $V_I = GND \text{ to } V_{CC}$	-	4.0	-	-	-	pF

Table 6. Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 10.

Symbol	Parameter	Conditions	Conditions		–40 °C to +85 °C			o +125 ℃	Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
t _{pd}	propagation	CP to Qn; see Figure 7	[2]		•				
	delay	$V_{CC} = 1.2 V$		-	16	-	-	-	ns
		$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$		2.2	7.4	16.3	2.2	18.8	ns
		V_{CC} = 2.3 V to 2.7 V		1.5	3.9	8.4	1.5	9.7	ns
	$V_{CC} = 2.7 V$		1.5	3.5	8.0	1.5	10.0	ns	
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.5	3.3	7.0	1.5	9.0	ns
t _{en} enable time	OE to Qn; see Figure 8	[2]							
	$V_{CC} = 1.2 V$		-	19	-	-	-	ns	
		V_{CC} = 1.65 V to 1.95 V		1.5	6.6	16.7	1.5	19.3	ns
		V_{CC} = 2.3 V to 2.7 V		1.5	3.7	9.3	1.5	10.8	ns
		$V_{CC} = 2.7 V$		1.5	3.8	8.5	1.5	11.0	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.5	3.0	7.5	1.5	9.5	ns
t _{dis}	disable time	OE to Qn; see Figure 8	[2]						
		V _{CC} = 1.2 V		-	8.0	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		2.3	4.0	10.1	2.3	11.7	ns
		V_{CC} = 2.3 V to 2.7 V		1.0	2.2	5.7	1.0	6.7	ns
		$V_{CC} = 2.7 V$		1.5	3.1	6.5	1.5	9.0	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.5	2.9	6.0	1.5	7.5	ns

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Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V). For test circuit see <u>Figure 10</u>.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	–40 °C to	o +125 ℃	Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max	_
W	pulse width	clock HIGH or LOW; see Figure 7							
		$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$		5.0	-	-	5.0	-	ns
		V_{CC} = 2.3 V to 2.7 V		4.0	-	-	4.0	-	ns
		$V_{CC} = 2.7 V$		3.0	-	-	4.5	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		3.0	1.5	-	4.5	-	ns
su	set-up time	Dn to CP; see <u>Figure 9</u>							
		V_{CC} = 1.65 V to 1.95 V		4.0	-	-	4.0	-	ns
		V_{CC} = 2.3 V to 2.7 V		3.0	-	-	3.0	-	ns
		$V_{CC} = 2.7 V$		2.0	-	-	2.0	-	ns
	V_{CC} = 3.0 V to 3.6 V		2.0	0	-	2.0	-	ns	
ĥ	hold time	Dn to CP; see Figure 9							
		$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$		3.0	-	-	3.0	-	ns
		V_{CC} = 2.3 V to 2.7 V		2.0	-	-	2.0	-	ns
		$V_{CC} = 2.7 V$		1.5	-	-	1.5	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.5	0.6	-	1.5	-	ns
max	maximum	see Figure 7							
	frequency	$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$		100	-	-	64	-	MHz
		V_{CC} = 2.3 V to 2.7 V		125	-	-	100	-	MHz
		$V_{CC} = 2.7 V$		150	-	-	120	-	MHz
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		150	-	-	120	-	MHz
sk(o)	output skew time	$V_{CC} = 3.0 V \text{ to } 3.6 V$	<u>[3]</u>	-	-	1.0	-	1.5	ns
C _{PD}	power	per flip-flop; $V_I = GND$ to V_{CC}	<u>[4]</u>						
	dissipation capacitance	$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$		-	11.6	-	-	-	pF
	capacitance	V_{CC} = 2.3 V to 2.7 V		-	13.6	-	-	-	pF
		$V_{CC} = 3.0 \text{ V}$ to 3.6 V		-	15.4	-	-	-	pF

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.8 V, 2.5 V, 2.7 V and 3.3 V respectively.

 t_{dis} is the same as t_{PLZ} and $t_{\text{PHZ}}.$

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 f_i = input frequency in MHz; f_o = output frequency in MHz

 C_L = output load capacitance in pF

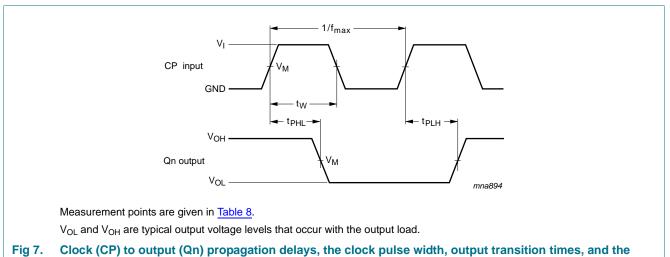
 V_{CC} = supply voltage in Volt

N = number of inputs switching

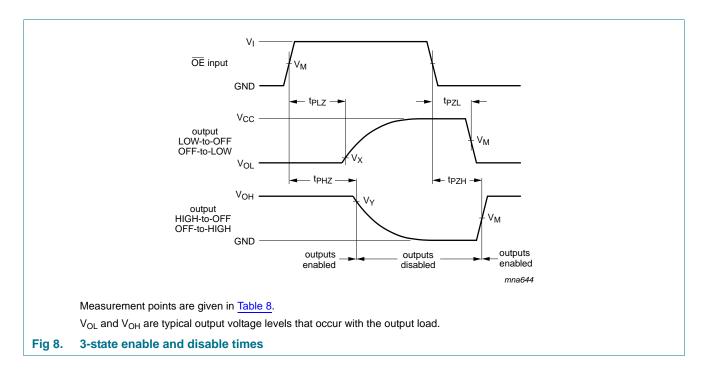
 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$ = sum of the outputs

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11. Waveforms



maximum frequency



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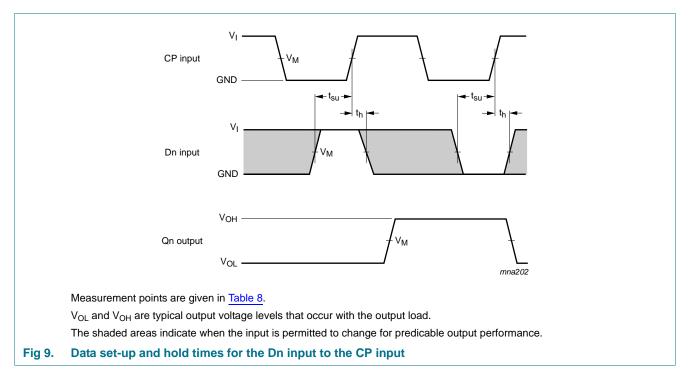


Table 8. Measurement points

Supply voltage	Input		Output		
V _{cc}	VI	V _M	V _M	V _X	V _Y
1.2 V	V _{CC}	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V
1.65 V to 1.95 V	V _{CC}	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V
2.3 V to 2.7 V	V _{CC}	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V
2.7 V	2.7 V	1.5 V	1.5 V	V _{OL} + 0.3 V	V _{OH} – 0.3 V
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V	V _{OL} + 0.3 V	V _{OH} – 0.3 V

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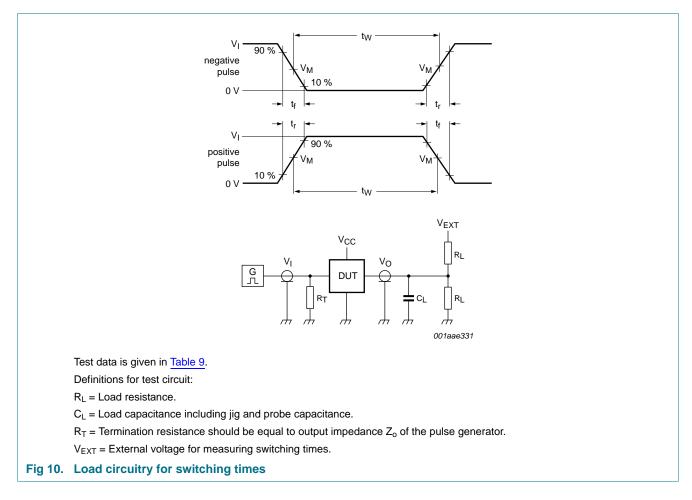


Table 9. Test data	Table	9.	Test	data
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Supply voltage	Input		Load		V _{EXT}	V _{EXT}		
V _{CC}	VI	t _r , t _f	CL	RL	t _{PLH} , t _{PHL}	t _{PLZ} , t _{PZL}	t _{PHZ} , t _{PZH}	
1.2 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2 \times V_{CC}$	GND	
1.65 V to 1.95 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND	
2.3 V to 2.7 V	V _{CC}	\leq 2 ns	30 pF	500 Ω	open	$2\times V_{CC}$	GND	
2.7 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND	
3.0 V to 3.6 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND	

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12. Package outline

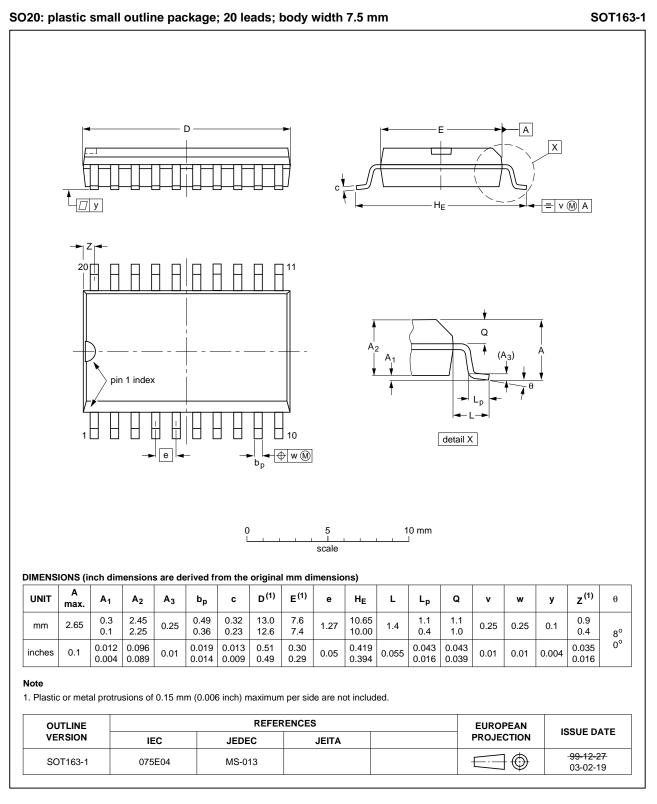


Fig 11. Package outline SOT163-1 (SO20)

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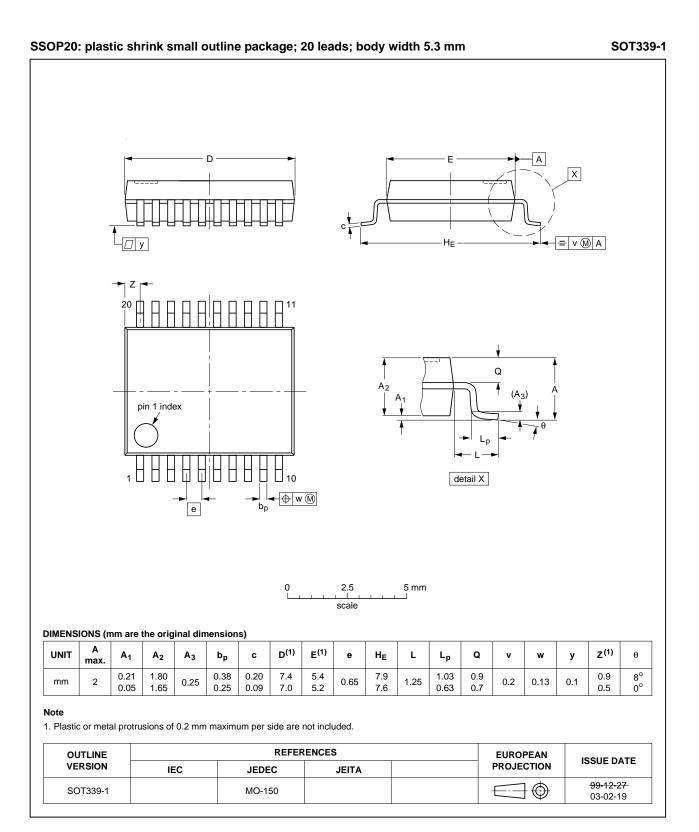


Fig 12. Package outline SOT339-1 (SSOP20)

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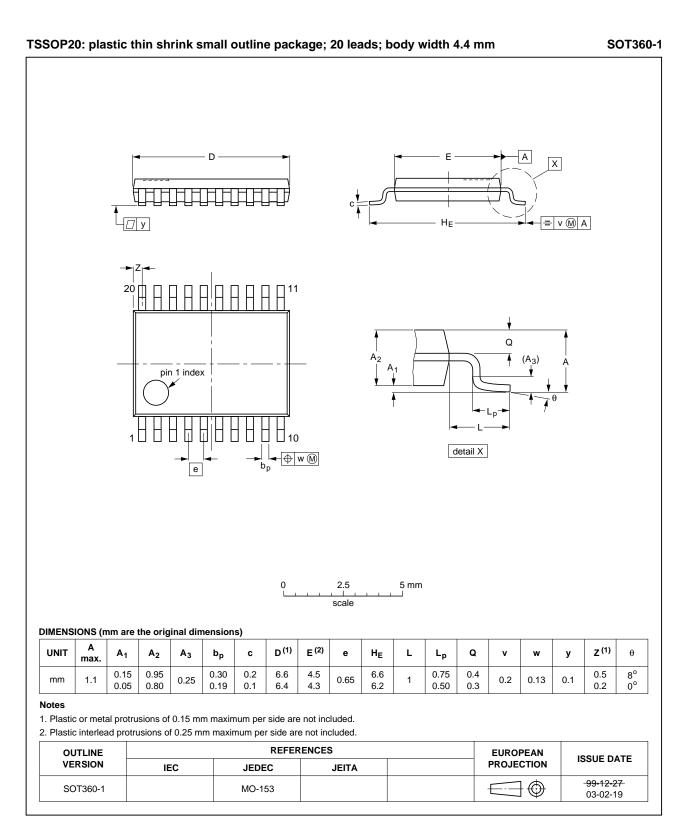
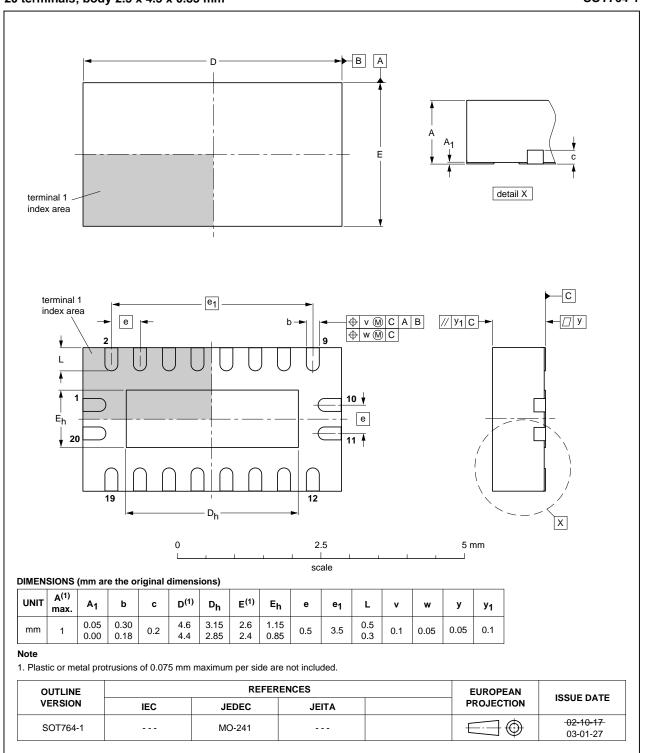


Fig 13. Package outline SOT360-1 (TSSOP20)

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DHVQFN20: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 x 4.5 x 0.85 mm SOT764-1

Fig 14. Package outline SOT764-1 (DHVQFN20)

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Octal D-type flip-flop; 5 V tolerant inputs/outputs; positive-edge trigger; 3-state

13. Abbreviations

Table 10.	Abbreviations
Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

14. Revision history

story			
Release date	Data sheet status	Change notice	Supersedes
20121206	Product data sheet	-	74LVC374A v.2
 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. 			
 Legal texts have been adapted to the new company name where appropriate. 			
• <u>Table 4</u> , <u>Table 5</u> , <u>Table 6</u> , <u>Table 7</u> , <u>Table 8</u> and <u>Table 9</u> : values added for lower voltage ranges.			
20030514	Product specification	-	74LVC374A v.1
19980729	Product specification	-	-
	Release date 20121206 • The format of this of NXP Semicondu • Legal texts have bu • Table 4, Table 5, Table 20030514	Release date Data sheet status 20121206 Product data sheet • The format of this data sheet has been redered of NXP Semiconductors. • Legal texts have been adapted to the new comparison of the text share been adapted to the new comparison of the text share been adapted to the new comparison of the text share been adapted to the new comparison of text share been adapted to text share been adapted t	Release date Data sheet status Change notice 20121206 Product data sheet - • The format of this data sheet has been redesigned to comply with the of NXP Semiconductors. - • Legal texts have been adapted to the new company name where apprevalues added - • Table 4, Table 5, Table 6, Table 7, Table 8 and Table 9: values added - 20030514 Product specification -

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Octal D-type flip-flop; 5 V tolerant inputs/outputs; positive-edge trigger; 3-state

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Octal D-type flip-flop; 5 V tolerant inputs/outputs; positive-edge trigger; 3-state

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